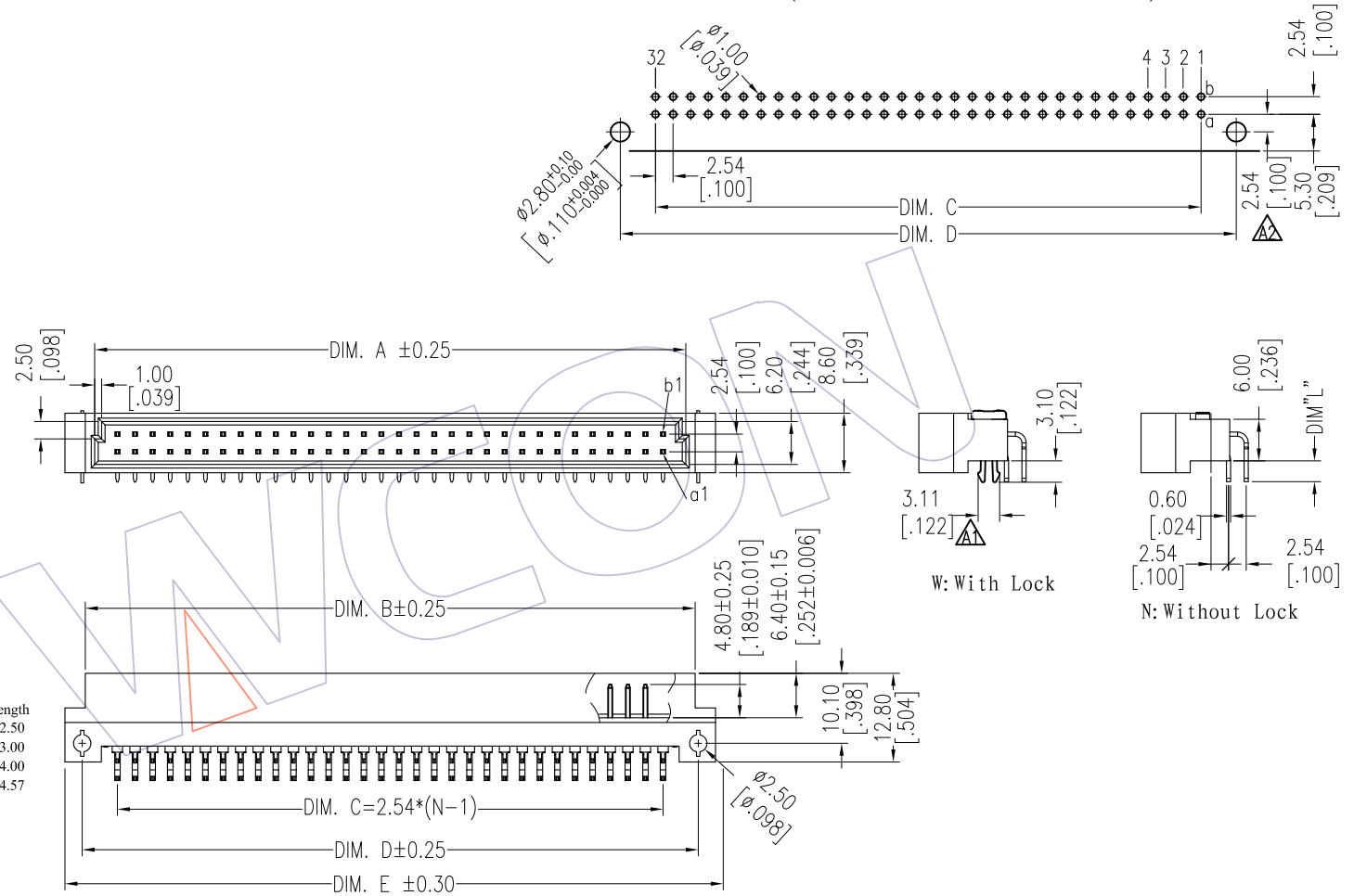


# HSF

Recommended P.C.B Layout(Top Side)  
(PCB BOARD TOLERANCE±0.05)

NOTES:  
 Current Rating: 3.0AMP  
 Contact Resistance:30mΩ max  
 Withstand Voltage:1000V AC/DC  
 Insulation Resistance:1000MΩ  
 Operation Temperature:-55℃~+105℃

Contact Material: Brass  
 Contact Plating: Au and Sn over Ni  
 Fixing Material: Phosphor Bronze  
 Fixing Plating: Sn over Ni  
 Insulator Material: PBT+30% G.F(UL94V-0)



## Ordering Information

3410-2 **XX** **X** MR **SX** **X** **A** **X**

No. of Pins Per Row:	Rows with Contacts	Contact Plating	Packing	DIP Length
10pin	B=a+b	S0=Gold Flash/Tin	A=Tray	1: L=2.50
16pin	D=a	S1=3u"Gold/Tin		2: L=3.00
32pin		S3=10u"Gold/Tin		3: L=4.00
		S4=15u"Gold/Tin	W=With Lock	4: L=4.57
		S5=30u"Gold/Tin	N=Without Lock	
		SN=Tin		

TYPE	PDS.	ROWS	N	DIM.A	DIM.B	DIM.C	DIM.D	DIM.E
B	64	2	32	85.20	88.00	78.74	88.90	94.00
B/2	32	2	16	44.56	47.36	38.10	48.26	53.36
B/3	20	2	10	29.32	32.12	22.86	33.02	38.12

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.	TITLE:	Customer NO.
A2	2015/06/04	Modify the P.C.B Layout	—	X.X ±0.40	JYHuang	2015/06/04	UNIT	mm inch	3410-2XXXMRSXXAX	2.54PITCH DIN 41612 Male 90° DIP (B-Type)	
A1	2014/08/12	Modify the dim	—	X.XX ±0.25	CHECK	DATE	SIZE	A4			
A0	2014/05/29	NEW	—	X.XXX ±0.15	APPROVE	DATE	SHEET	1/1			
				Angle DIM TOL ± 3'			PROJ.	⊕			